

1 Infrastructure

1.1 Power Supply

The two main devices that need to be powered are the FEE and the SiPM's. The FEE as they are foreseen at the moment require a 12 V supply. The needs of the SiPM's depend on the chosen SiPM model. Since four SiPM's are connected in series and the necessary applied voltage adds up, small differences in the operational voltage of individual SiPM's can change the requirements on the power supply.

In case Hamamatsu SiPM's with an operational voltage of ~ 60 V are used the power supply is required to deliver voltages upwards of 240 V.

The TOFPET ASIC system that is foreseen as the base of the FEE is equipped with an internal power supply however only capable of delivering voltages up to around 90 V. As shown this might not be sufficient. In this case an external power source is required.

The performance of the SiPM's is also dependant on the applied overvoltage. Since the manufacturing of the SiPM's is not perfect slight variations in the breakdown voltages of every SiPM are to be expected. These variations lead to differences in the applied overvoltage and would need to be adjusted for to ensure identical performance of every detector module, meaning individual power supply channels for every readout channel. This however is not feasible for the 3840 channels of the detector.

does this need explaining?

Alternatively multiple detector module can be connected to the same biasing line. Measurements done in Erlangen with Hamamatsu S13360-3050PE SiPM's to determine the optimal bias voltage for each side of the detector showed a slight performance dependance. If the SiPM's are pre-sorted and grouped by breakdown voltage the overvoltage mismatch can be minimized.

1.2 Light Tight Enclosure

To ensure minimal noise from stray photons the detector super-modules need to be packed in a light tight enclosure. Similar to the Barrel DIRC it is foreseen that the carbon holding frame will act as the photon barrier.

1.3 Water Cooling of FEE

The main active component of the B-ToF detector is the FEE placed at the end of the detector in front of the interaction point. As the main heat source of the detector it is foreseen to be water cooled.

Each channel of the TOFPET2 ASIC by PETsys dissipates 8.2 mW of heat. For the 240 channels of the Super-Module this adds up to 2 W of heat energy. In addition to that the TOFPET2 ASIC's need to be read out by FEB-D of the PETsys system, of which one is required per Super-Module.

this does not take the other boards FEB/S and FEB/I into account. I dont know if they are necessary.

What power draw does the TOFPET ASIC FEB/D have? This needs to be included.

1.4 Air Cooling

Although there is a minimal amount of electrical components placed along the Rail-Board some heat will still be generated; mainly by the SiPM's. Since the SiPM performance also is very dependant on the temperature a slight draft of pressured air along the Rail-Board should keep everything dry and produce a constant temperature.